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**PATENT APPLICATION**

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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**Applicant:** Bogursky et al.

**Application No.:** 10/084,125

**Filed:** 2/28/02

**Art Unit:** 3729

**Examiner:**

**For:** Discrete Solder Ball Contact, etc.

**Commissioner Of Patents And Trademarks**

**Washington, D.C. 20231**

**Sir:**

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**AUG - 8 2002**

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**PRELIMINARY AMENDMENT**

Subject to the Examiner's approval, enclosed herewith are 5 sheets of new formal drawings, which if approved please forward to the Chief Draftsperson together with the accompanying letter.

Respectfully submitted,  
R. Bogursky et al.

J. Oisher, attorney  
Reg. No. 17317

7/29/02

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